04 - 26 -	2000 FLH Ref. No.: 450100-408	
1100 4.3.00	T U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office	
To the Honorable Commissioner of Patc 101336	5517ctached original documents or copy thereof.	
1. Name of conveying party(ies)	2. Name and address of receiving party(ies) Name: SONY CORPORATION 7-35 Kitashinagawa 6-chome	
TAKESHI OMOTO, NOBORU MOTOYOSHI, TOSHIYUKI KATSUMOTO	7-35 Eitashinagawa 6-chome Shinagawa Ku, Tokyo 100-31, Japan	
Additional name(s) of conveying party(ies) attached? Yes No	Additional name(s) & address(es) attached? Yes x No	
3. Nature of conveyance:	11 Maritime and an analysis an	
Assignment Security Agreement Merger Change of Name		
X Other: Corrective Assignment to correct the Assignme in deed of Assignment recorded at Reel/Frame: 9458/0494		
Execution Date(s): <u>July 22, August 5, and August 6, 1998</u>		
4. Application number(s) or patent number(s):		
If this document is being filed together with a new application, the execution date of the application is:		
A. Patent Application No.(s) <u>08/889,984</u> filed <u>July 10</u>	, 1997	
Additional numbers attached? <u>Y</u> es <u>X</u> Wo		
 Name and address of party to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved 1	
Name: WILLIAM S. FROMMER	7. Total fee (37 CFR 3.41)	
Internal Address: FROMMER LAWRENCE & HAUG LLP	X Enclosed Authorized to be charged to deposit account 50-0320	
Street Address: 745 FIFTH AVENUE City: NEW Y.DRK State: N.Y. Zip: 10151	8. Deposit account number: (Attach duplicate copy of this page if paying by deposit account)	
Do not use this space		
9. Statement and signature. To the best of my knowledge and belief, the foregoing inforcopy of the original document.	rmation is true and correct and any attached copy is a true	
WILLIAM S. FROMMER	March 29, 2000	
Name of Person Signing State	ature Date Total number of pages including cover sheet, attachments, and document: 6	
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Mail documents to be recorded with required cover sheet information to:		

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Commissioner of Patents and Trademarks Box Assignments Washington, D.C. 20231

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: \SONY\4085\asg over.rec (WSF:1k)

PATENT REEL: 010720 FRAME: 0240



Docket	Number:	

ASSIGNMENT

whereas, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in VIDEO-SIGNAL PLAYBACK APPARATUS AND ITS OPERATION CONTROL METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan, and Sony Chemicals Corporation, a Japanese corporation with offices at 1-6, Nihonbachi Muromachi, Chuo-ku, Tokyo, Japan 3/2/o, (hereinafter referenced as ASSIGNES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, 'in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hepeafter require and prepare at its own expense;

And I further agree that ASSIGNES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto:

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 08/889.984 , Filing Date: 7/10/1997

This assignment executed on the dates indicated below.

TAKESHI OMOTO

Name of first or sole inventor

CHIBA, JAPAN

Residence of first or sole inventor

Takah

Signature of first or sole inventor

Date of this assignment

136639 091 131

PATENT REEL: 010720 FRAME: 0241



NOBORU MOTOYOSHI	Aug. 5. 1988
Name of second joint inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of second joint inventor	Aug. 5 1998 Date of this assignment
Signature of second joint inventor	Date of this assignment
TOSHIYUKI KATŞUMOTO	Aug. 6, 1998 Execution date of U.S. Patent Application
Name of third joint inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of third joint inventor	Aug. 6. 1998 Date of this assignment
Signature of third joint inventor	Date of this assignment
Name of fourth join: inventor	Execution date of U.S. Patent Application
Residence of fourth joint inventor	
Signature of fourth joint inventor	Date of this assignment
Name of fifth joint inventor	Execution date of U.S. Patent Application
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Residence of fifth joint inventor	
Signature of fifth joint inventor	Date of this assignment

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PATENT REEL: 010720 FRAME: 0242

ASSIGNMENT



NHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

VIDEO-SIGNAL PLAYBACK APPARATUS AND ITS OPERATION CONTROL METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to
my name and address;

AND WHEREAS, SOMY CORPORATION, a Japanese corporation, with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141, Japan Chereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

Protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the united States and in any and all foreign countries;

NOW THEREFORE, in consideration of the unit of one pollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said AstidueE, its successors, assigns, and ispain representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all letters Patent of the United States, and countries foreign therstowhich may be granted for said invention, and in and to any and all privative rights and/ar convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and industrial Models, and any other internstinals agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to se with respect to the filling of applications for patents or securing of patents to issue the said United States Letters Patent to said ABSIGNEE, as the assignme of the whole right, titls and interest thereo;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNES or its designee, as ASSIGNES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawfut papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Latters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I heraby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Scrial Number: 08/809.984, Filing Date: July 10, 1997.

This assignment executed on the dates indicated below.

INVESTIT CHOIC	
Name of first or sole inventor	Execution date of U.S. Patent Application
Chiba. Japan	
Residence of first or sole inventor Takash' Onto	29. Man. 2000.
Signature of first or sole inventor	Date of this assignment
HOBORU HOTOYOSHI	
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of second inventor	29. Mar. 2000
Signature of separt inventor	Date of this assignment
TOSHIYUKI KATSUNOTO	
Name of third inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of third inventor Traditudi Katalaneta	29. Mar. 2000
Signature of third inventor	Date of this assignment

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Page 1 of 1

PATENT REEL: 010720 FRAME: 0243

RECORDED: 04/03/2000